

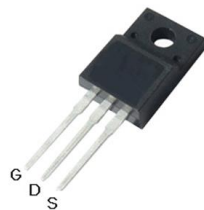
**Features**

- 650V, 8A
- $R_{DS(ON)} = 1.4\Omega$  (Max.) @  $V_{GS} = 10V, I_D = 4A$
- Fast switching
- 100% avalanche tested
- Improved dv/dt capability
- RoHS and Halogen-Free Compliant

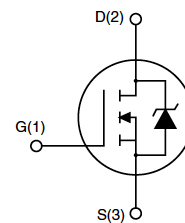
**Application**

- Switch Mode Power Supply (SMPS)
- Uninterruptible Power Supply (UPS)
- Power Factor Correction (PFC)

**Package**



**TO-220F**  
**MPF8N65**



**Absolute Maximum Ratings**  $T_C=25^\circ C$  unless otherwise specified

Symbol	Parameter	Max.	Units
$V_{DSS}$	Drain-Source Voltage	650	V
$V_{GSS}$	Gate-Source Voltage	$\pm 30$	V
$I_D$	Continuous Drain Current <small>note5</small>	8	A
	$T_C = 25^\circ C$		
$I_{DM}$	Pulsed Drain Current <small>note3</small>	32	A
$P_D$	Power Dissipation <small>note2</small>	35	W
	$T_C = 25^\circ C$		
$E_{AS}$	Single Pulse Avalanche Energy <small>note3,6</small>	281	mJ
$R_{\theta JC}$	Thermal Resistance, Junction to Case	3.6	$^\circ C/W$
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient <small>note1,4</small>	62.5	$^\circ C/W$
$T_J, T_{STG}$	Operating and Storage Temperature Range	-55 to +150	$^\circ C$

**Electrical Characteristics**  $T_C=25^{\circ}\text{C}$  unless otherwise specified

Symbol	Parameter	Test Condition	Min.	Typ.	Max.	Units
<b>Off Characteristic</b>						
$BV_{DSS}$	Drain-Source Breakdown Voltage	$V_{GS} = 0V, I_D = 250\mu A$	650	-	-	V
$I_{DSS}$	Drain-Source Leakage Current	$V_{DS} = 650V, V_{GS} = 0V$	-	-	1	$\mu A$
$I_{GSS}$	Gate to Body Leakage Current	$V_{DS} = 0V, V_{GS} = \pm 30V$	-	-	$\pm 100$	nA
<b>On Characteristics</b>						
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = 250\mu A$	2	-	4	V
$R_{DS(on)}$	Static Drain-Source On-Resistance	$V_{GS} = 10V, I_D = 4A$	-	1.17	1.4	$\Omega$
<b>Dynamic Characteristics</b>						
$C_{iss}$	Input Capacitance	$V_{DS} = 25V, V_{GS} = 0V,$ $f = 1.0MHz$	-	870	-	pF
$C_{oss}$	Output Capacitance		-	97	-	pF
$C_{rss}$	Reverse Transfer Capacitance		-	9.6	-	pF
<b>Switching Characteristics</b>						
$Q_g$	Total Gate Charge	$V_{DS} = 520V, I_D = 8A,$ $V_{GS} = 10V$	-	22	-	nC
$Q_{gs}$	Gate-Source Charge		-	5	-	
$Q_{gd}$	Gate-Drain("Miller") Charge		-	5.5	-	
$t_{d(on)}$	Turn-On Delay Time	$V_{DS} = 100V, I_D = 8A,$ $R_G = 25\Omega, V_{GS} = 10V$	-	12	-	ns
$t_r$	Turn-On Rise Time		-	20	-	
$t_{d(off)}$	Turn-Off Delay Time		-	74	-	
$t_f$	Turn-Off Fall Time		-	33	-	
<b>Diode Characteristics</b>						
$V_{DS}$	Diode Forward Voltage <sup>note3</sup>	$I_S = 8A, V_{GS} = 0V$	-	-	1.4	V
$t_{rr}$	Reverse Recovery Time	$I_{SD} = 8A, V_{GS} = 0V$	-	506	-	ns
$Q_{rr}$	Reverse Recovery Charge	$di_{SD}/dt = 100A/\mu s$	-	2.7	-	nC

## Notes:

- The value of  $R_{\theta JC}$  is measured in a still air environment with  $T_A = 25^{\circ}\text{C}$  and the maximum allowed junction temperature of  $150^{\circ}\text{C}$ . The value in any given application depends on the user's specific board design.
- The power dissipation  $P_D$  is based on  $T_{J(MAX)} = 150^{\circ}\text{C}$ , using junction-to-case thermal resistance, and is more useful in setting the upper dissipation limit for cases where additional heatsinking is used.
- Single pulse width limited by junction temperature  $T_{J(MAX)} = 150^{\circ}\text{C}$ .
- The  $R_{\theta JA}$  is the sum of the thermal impedance from junction to case  $R_{\theta JC}$  and case to ambient.
- The maximum current rating is package limited.
- The EAS data shows Max. rating. The test condition is  $V_{DS} = 50V, V_{GS} = 10V, L = 10mH$

## Typical Performance Characteristics

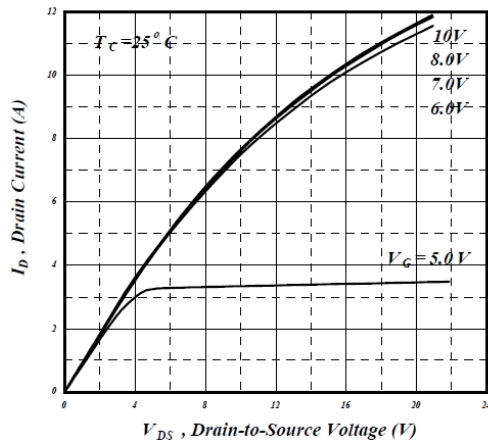


Figure 1. Output Characteristics

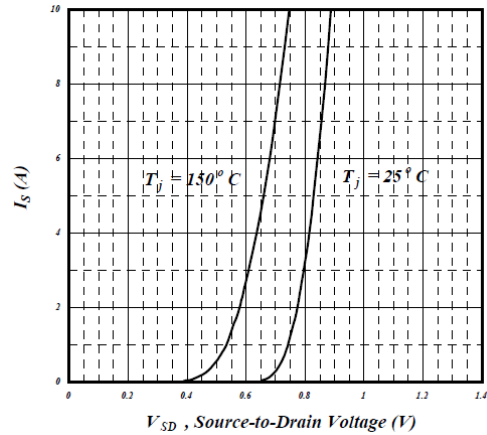


Figure 2. Body Diode Forward Voltage vs Source Current and Temperature

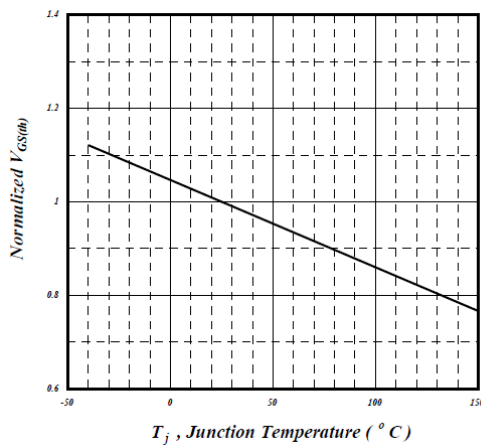


Figure 3. Normalized On Resistance vs Junction Temperature

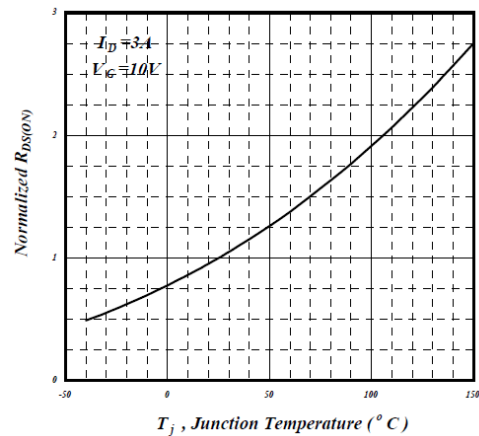


Figure 4. Normalized On Resistance vs Junction Temperature

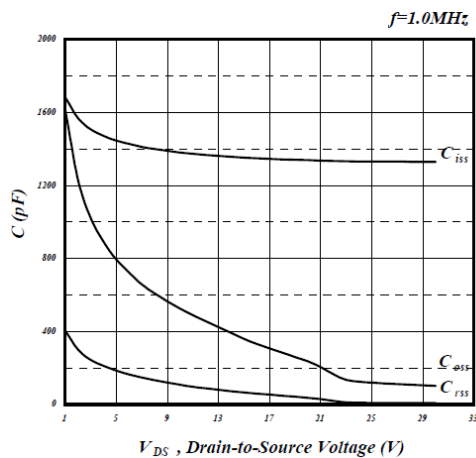


Figure 5. Capacitance Characteristics

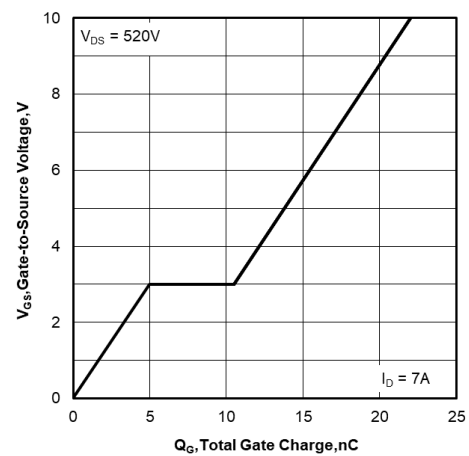


Figure 6. Gate Charge Characteristics

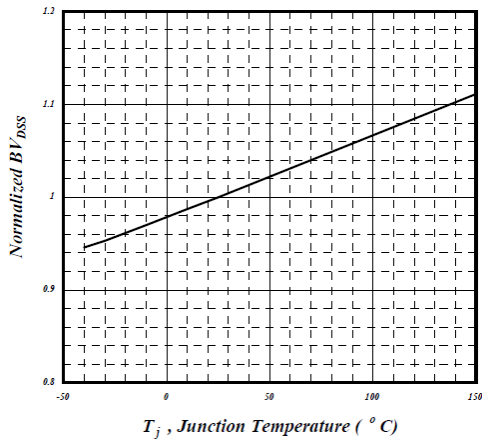


Figure 7. Normalized Breakdown Voltage vs Junction Temperature

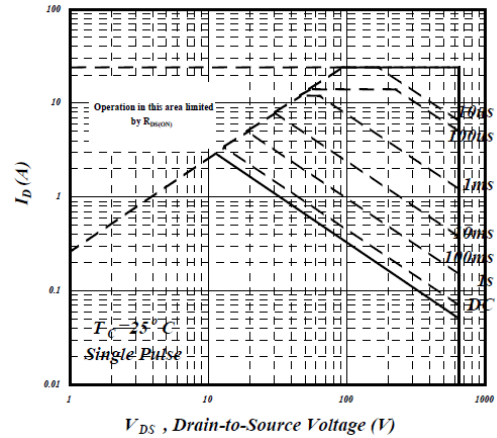


Figure 8. Maximum Safe Operating Area

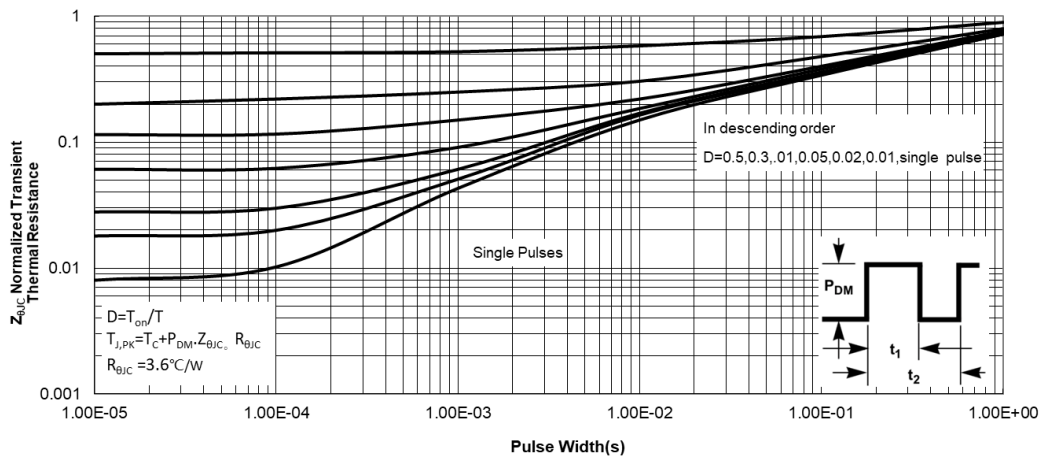
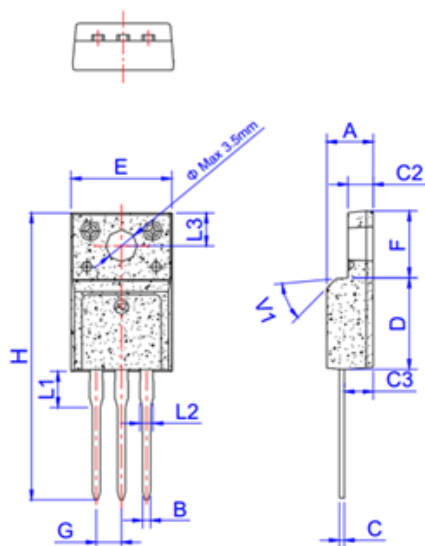


Figure 9. Maximum Effective Transient Thermal Impedance, Junction-to-Case

### TO-220F Package Mechanical Data



Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	4.50		4.90	0.177		0.193
B	0.74	0.80	0.83	0.029	0.031	0.033
C	0.47		0.65	0.019		0.026
C2	2.45		2.75	0.096		0.108
C3	2.60		3.00	0.102		0.118
D	8.80		9.30	0.346		0.366
E	9.80		10.4	0.386		0.410
F	6.40		6.80	0.252		0.268
G		2.54			0.1	
H	28.0		29.8	1.102		1.173
L1		3.63			0.143	
L2	1.14		1.70	0.045		0.067
L3		3.30			0.130	
V1		45°			45°	

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